FIG.1A

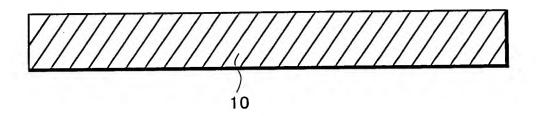


FIG.1B

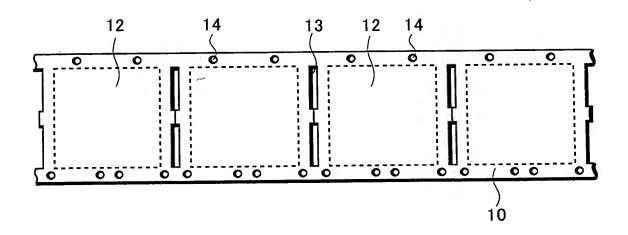
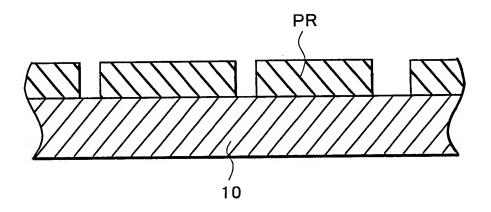


FIG.2



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FIG.3A

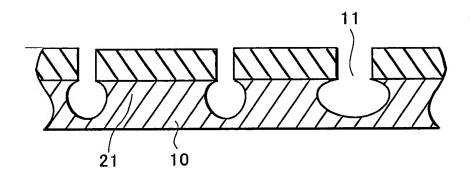


FIG.3B

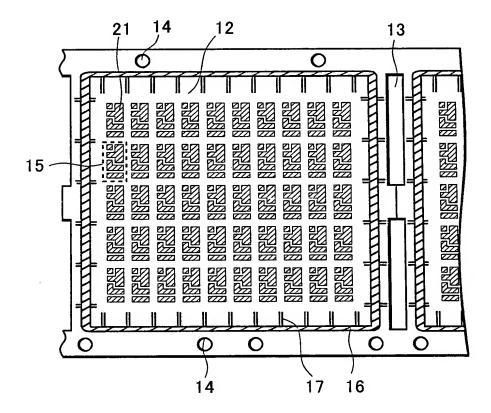


FIG.4

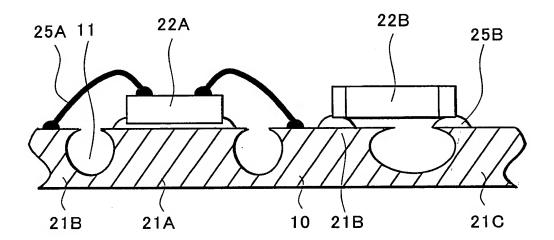


FIG.5A

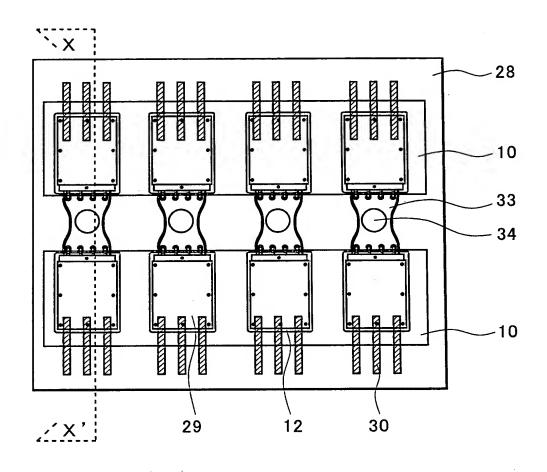
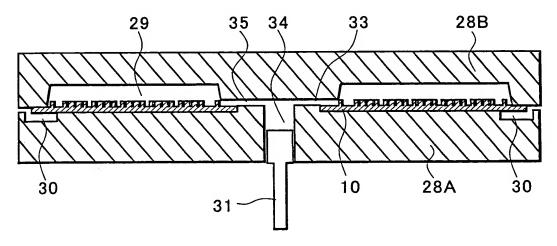
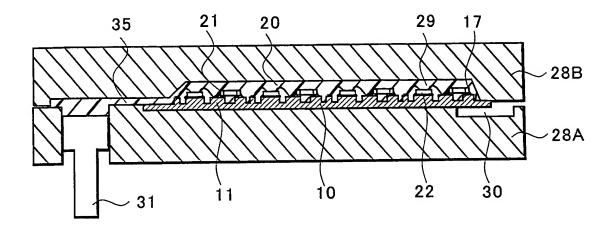


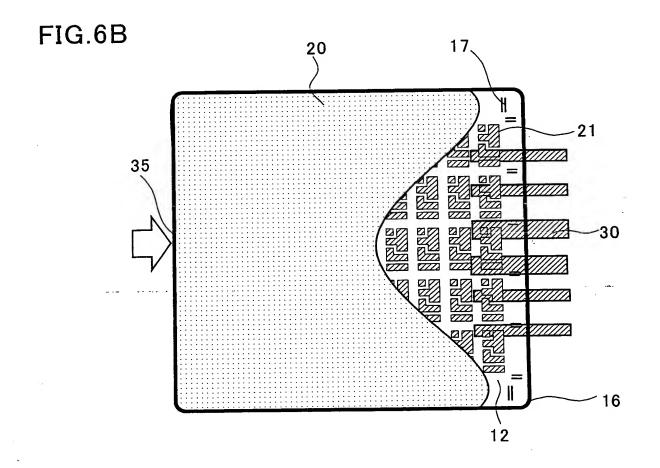
FIG.5B



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FIG.6A





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FIG.7A

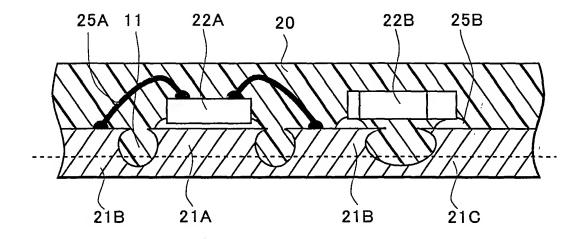
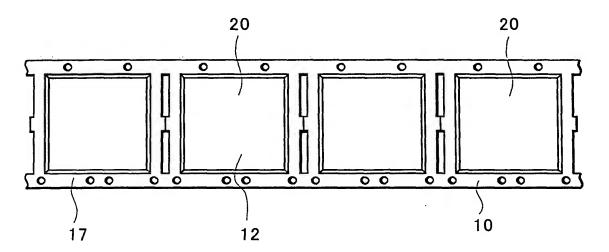


FIG.7B



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FIG.8

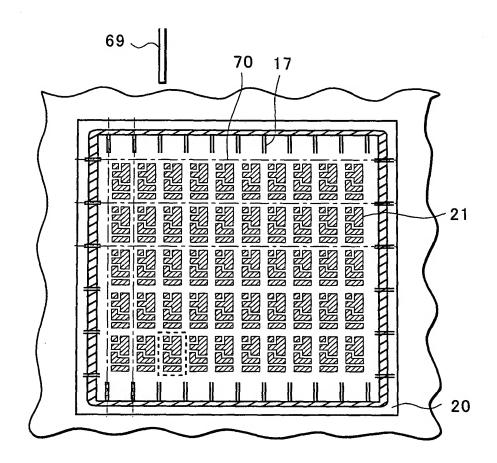
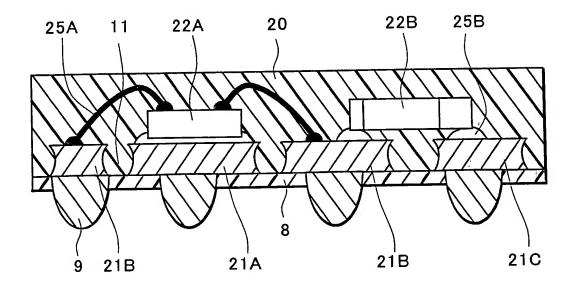


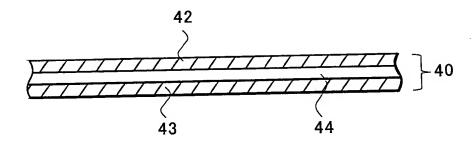
FIG.9



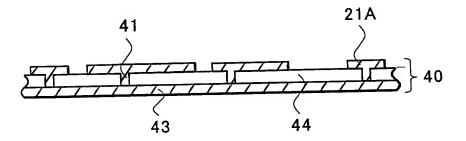
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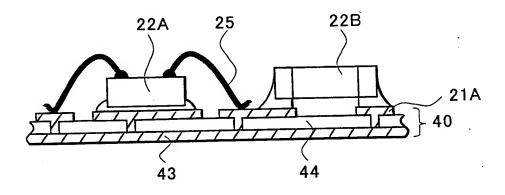
## FIG.10A



## FIG.10B



## FIG.10C



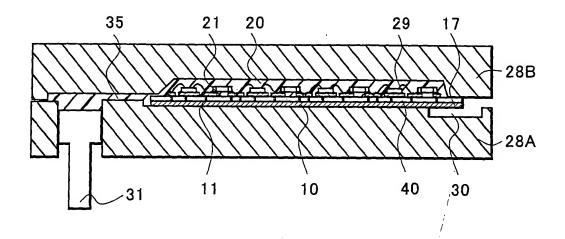
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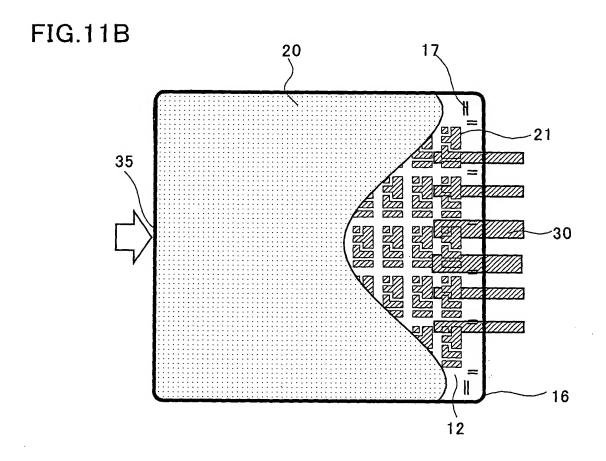
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FIG.11A





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FIG.12A

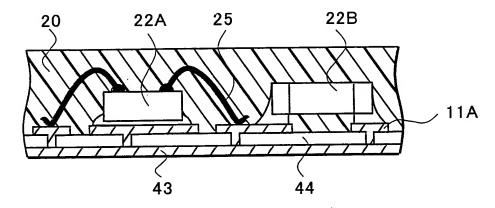


FIG.12B

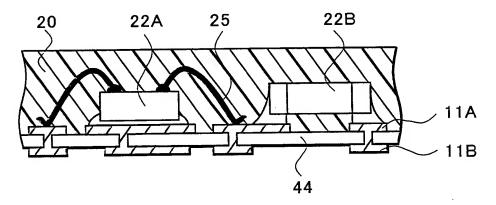
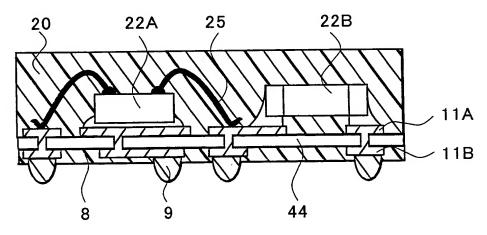


FIG.12C



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FIG.13A

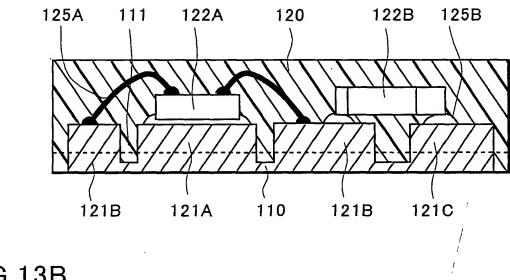


FIG.13B

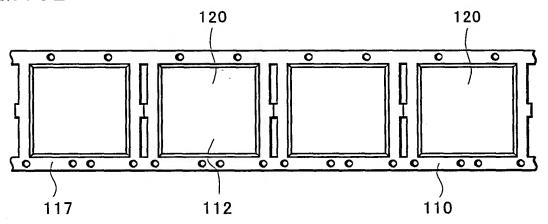


FIG.13C

